CLAIMS

1. A cover film having at least a substrate layer and a sealant resin layer,

wherein the sealant resin layer is formed in contact with one surface of the substrate layer or is formed on an intermediate resin layer contacting one surface of the substrate layer, and

the sealant resin layer contacting the substrate layer or the intermediate resin layer contacting the substrate layer comprises an epoxidized fatty acid or a derivative thereof

2wherein the epoxidized fatty acid or a derivative thereof in the sealant resin layer contacting the substrate layer or in the intermediate resin layer contacting the substrate layer is at a content of from 0.00001 to 0.5 parts by mass with respect to 100 parts by mass of a resin component constituting the sealant resin layer contacting the substrate layer or the intermediate resin layer contacting the substrate layer and

wherein the sealant resin layer comprises one or more selected from the following [1] to [3]:

[1] a resin composition that comprises a styrene-diene block copolymer-containing styrene-based resin and an ethylene-α-olefin random copolymer;

[2] a hydrogenated product of an aromatic vinyl-conjugated diene copolymer comprising 15-45 mass% of an aromatic vinyl-derived monomer unit;

[3] an ethylene-vinyl acetate copolymer comprising 70-91 mass% of an olefin component.

2. The cover film of claim 1, wherein the intermediate resin layer comprises a polyethylene resin.

3. The cover film of claim 2, wherein the polyethylene resin has a density of 0.85-0.95 g/cm^3.

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4. The cover film of any one of claims 1 to 3, wherein the substrate layer comprises one or more selected from a biaxially stretched polyester and a biaxially stretched polypropylene.

5. The cover film of any one of claims 1 to 4, wherein a surface of the substrate layer, which does not contact the sealant resin layer or the intermediate resin layer, and/or a surface of the sealant resin layer, which does not contact the substrate layer

or the intermediate layer, comprises an anti-static agent.

6. The cover film of claim 5, wherein the anti-static agent comprises one or more selected from a surfactant, tin oxide, zinc oxide, titanium oxide, and carbon black, and the surface comprising the anti-static agent has a surface resistance of 1×10^{13} Ω/□ or less.

7. Use of the cover film of any one of claims 1 to 6 as a lid material for a carrier tape comprising a thermoplastic resin.

8. An electronic component package having: a lid material using the cover film of any one of claims 1 to 6; and carrier tape using a thermoplastic resin.